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September 2001

FDS6375

P-Channel 2.5V Specified PowerTrench[®] MOSFET

General Description

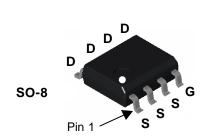
This PChannel 2.5V specified MOSFET is a rugged gate version of Fairchild Semiconductor's advanced PowerTrench process. It has been optimized for power management applications with a wide range of gate drive voltage (2.5V - 8V).

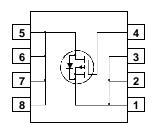
Applications

- Power management
- Load switch
- Battery protection

Features

- -8 A, -20 V. $R_{DS(ON)} = 24 \text{ m}\Omega @ V_{GS} = -4.5 \text{ V}$ $R_{DS(ON)} = 32 \text{ m}\Omega @ V_{GS} = -2.5 \text{ V}$
- Low gate charge (26 nC typical)
- + High performance trench technology for extremely low $R_{\text{DS}(\text{ON})}$
- High current and power handling capability





Absolute Maximum Ratings T_A=25°C unless otherwise noted

Symbol	Parameter		Ratings	Units
V _{DSS}	Drain-Source Voltage		-20	V
V _{GSS}	Gate-Source Voltage		±8	V
Ь	Drain Current – Continuous	(Note 1a)	-8	A
	- Pulsed		-50	
PD	Power Dissipation for Single Operation	(Note 1a)	2.5	W
		(Note 1b)	1.2	
		(Note 1c)	1.0	
T _J , T _{STG}	Operating and Storage Junction Temperat	ure Range	-55 to +175	°C
Therma	I Characteristics	·		
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient	(Note 1a)	50	°C/W
R _{0JA}	Thermal Resistance, Junction-to-Ambient	(Note 1c)	125	°C/W
R _{eJC}	Thermal Resistance, Junction-to-Case	(Note 1)	25	°C/W

Package Marking and Ordering Information

Device Marking	Device	Reel Size	Tape width	Quantity
FDS6375	FDS6375	13"	12mm	2500 units

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FDS6375

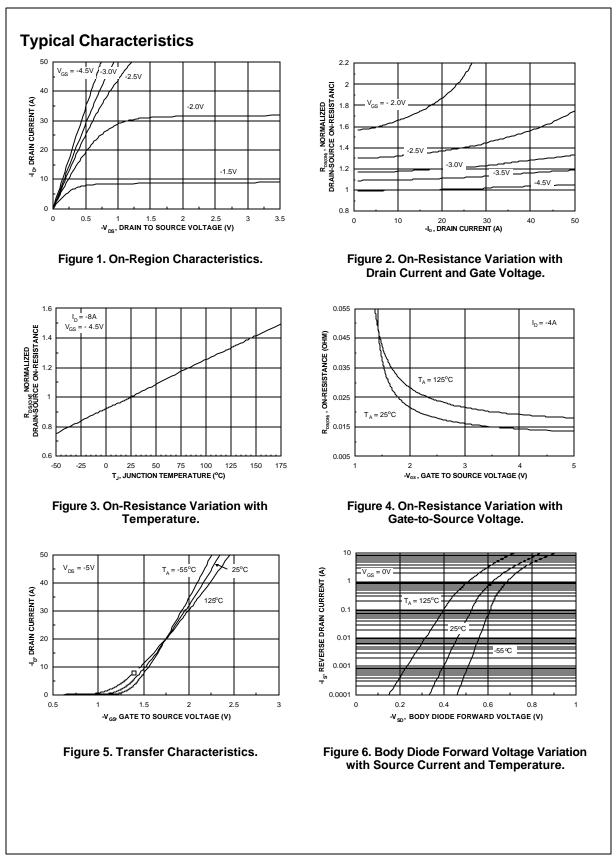
Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Char	acteristics					
BV _{DSS}	Drain–Source Breakdown Voltage	$V_{GS} = 0 V, I_D = -250 \mu A$	-20		[V
$\frac{\Delta BV_{DSS}}{\Delta T_J}$	Breakdown Voltage Temperature Coefficient	$I_D = -250 \ \mu\text{A}$, Referenced to 25°C		-13		mV/°C
DSS	Zero Gate Voltage Drain Current	$V_{DS} = -16 V$, $V_{GS} = 0 V$			-1	μA
GSSF	Gate-Body Leakage, Forward	$V_{GS} = 8 V$, $V_{DS} = 0 V$			100	nA
GSSR	Gate–Body Leakage, Reverse	$V_{GS} = -8 \text{ V}, \qquad V_{DS} = 0 \text{ V}$			-100	nA
On Char	acteristics (Note 2)	·		•	•	•
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = -250 \ \mu A$	-0.4	-0.7	-1.5	V
$\Delta V_{GS(th)} \Delta T_J$	Gate Threshold Voltage Temperature Coefficient	$I_D = -250 \ \mu\text{A}$, Referenced to 25°C		3		mV/°C
R _{DS(on)}	Static Drain–Source	$V_{GS} = -4.5 \text{ V}, I_D = -8 \text{ A}$		14	24	mΩ
	On-Resistance	$V_{GS} = -2.5 V$, $I_D = -7 A$		19	32	
		$V_{GS} = -4.5 \text{ V}, \text{ I}_D = -8\text{A}, \text{ T}_J = 125^{\circ}\text{C}$		18	39	
D(on)	On–State Drain Current	$V_{GS} = -4.5 V, V_{DS} = -5 V$	-50	05		A
g fs	Forward Transconductance	$V_{DS} = -5 V$, $I_D = -8 A$		35		S
	Characteristics	1		T	1	1
C _{iss}	Input Capacitance	$V_{DS} = -10 V$, $V_{GS} = 0 V$,		2694		pF
Coss	Output Capacitance	f = 1.0 MHz		480		pF
Crss	Reverse Transfer Capacitance			229		pF
Switchir	g Characteristics (Note 2)					
t _{d(on)}	Turn–On Delay Time	$ \begin{array}{ll} V_{\text{DD}} = -10 \text{V}, & I_{\text{D}} = -1 \text{A}, \\ V_{\text{GS}} = -4.5 \text{V}, & R_{\text{GEN}} = 6 \Omega \end{array} $		12	22	ns
t _r	Turn–On Rise Time			9	17	ns
t _{d(off)}	Turn–Off Delay Time			124	197	ns
t _f	Turn–Off Fall Time			57	92	ns
Qg	Total Gate Charge	$V_{DS} = -10 V$, $I_D = -8 A$,		26	36	nC
Q _{gs}	Gate–Source Charge	$V_{GS} = -4.5 V$		5		nC
Q _{gd}	Gate-Drain Charge			6		nC
Drain-Se	ource Diode Characteristics	and Maximum Ratings				
ls	Maximum Continuous Drain–Source	Diode Forward Current			-2.1	Α
V _{SD}	Drain–Source Diode Forward Voltage	$V_{GS} = 0 V, I_S = -2.1 A$ (Note 2)		-0.7	-1.2	V
	of the junction-to-case and case-to-ambient thermal r R _{0JC} is guaranteed by design while R _{0CA} is determine a) 50 °C/W when mounted on a 1ir ²				vhen mounte	

Scale 1 : 1 on letter size paper

669e

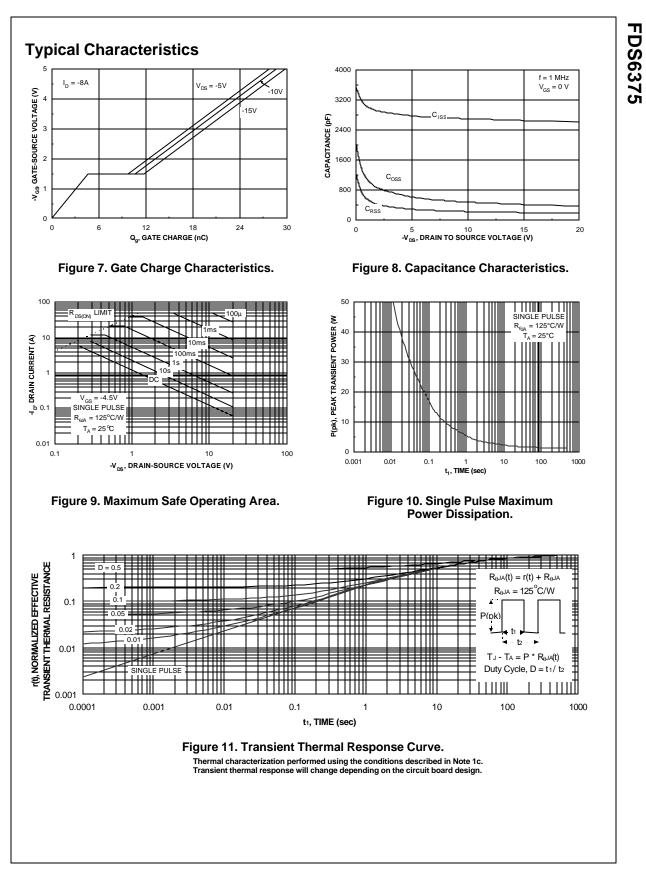
2. Pulse Test: Pulse Width < 300 μ s, Duty Cycle < 2.0%

FDS6375 Rev E(W)



FDS6375 Rev E(W)

FDS6375



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